INT OR SOLE) FOR PATENT APPLICATION FLH File No. 450100-02737

(Under 37 CFR § 1.63; with Power of Attorney) FROMMER LAWRENCE & HAUG LLP

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first

I believe I am the original, first and sole inventor (if only one name is listed below) or the subject matter which is claimed and for which a patent is

and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is AND METHOD, AND DECODDING MEDIUM HIGED THEREWITH sought on the invention ENTITLED:

and joint inventor (if pto. sought on the invention ENTITLED:		CORDING MEDIUM USED TH	HEREWITH
and joint inventor (T) purples sought on the invention ENTITLED: TRANSLATING APPARATUS AN	D METHOD, AND RE	CORDING	
the enecification of which			
is attached hereto.		sial No.	_•
	_ as Application se	rial No (if applicable, gi	ve dates).
with amendment(s) through I hereby state that I have reviewed an I hereby state that I have reviewed an		to of the above-identified	specification, including
with amendment(s) through I have reviewed an	nd understand the con	tents of the above	
the claims, as amended by the disclose to I acknowledge the duty to disclose to to be material to patentability as defined in to be material to patentability as defined in I hereby claim foreign priority benefit and the state of the state	the United States in Title 37, Code of Fe its under Title 35, L blow and have also id	deral Regulations, Sec. 1.56. United States Code, § 119 of lentified below any foreign appropriate transfer on which priority is	any foreign application(s)
Prior Foreign Application(s) [List Number:	ry: Fi	led (Day/Month/Year): 30 September 1999	Yes NO
I hereby appoint WILLIAM S. FROMMER Procedure their duty and to transact all bus provided by the fire and the support and the provided by duty to disclose to the United States patent by duty to disclose to the United States patent and the prior application and the nation of the prior application and the nation of the prior application and the nation Applin. Ser. Number: Filed (Day/MC Applin. Ser. N	the first paragraph and Trademark Office f Federal Regulation at on PCT internation itional applications nth/Year). 3. Registration No. neys, with full power ents therein, to file iness in the Patent e ones about the applice	all information known to me , Sec. 1.56, which became av nal filing date of this appli on separate pagel: Status (patented, pending, 25,506, and DENNIS M. SMI of substitution and revocati continuation and divisional dirademark Office and in the tion are to be directed to the Direct all telephone call (212) 588-0800 to the attention of: WILLIAM S. FROMMER OWN KNOWLEGGE are were made	to be material statements made on with the knowledge that
willful false statements and that	c such willful false	Statement	
mor any patent root		Date:	
FET WAEM LOK (2)	CHTMOMIDA	Ducc.	
Full name of sole or first inventor:	Hideki SHIMOMURA Kanagawa, Japan		
Residence:	Japan		
Residence: Citizenship:		Date:	
Signature: Full name of 2nd joint inventor (if any): Residence:	Kazuhiko TAJIMA Tokyo, Japan Japan		
Citizenship:		Date:	
Signature: Full name of 3rd joint inventor (if any): Residence: Citizenship:	Japan		
[Similarly list additional inventors on a Post Office Address(es) of inventor(s): [if all inventors have the same post off	ice address]	Sony Corporation 7-35 Kitashinagawa 6-cl Shinagawa-Ku, Tokyo 14 U. Sorities, each inventor an	d any other individual or entit
Note: In order to qualify for reduced f having rights to the invention must also Supporting a Claim by Another for S small Nonprofit Organization, individual Non-I		separate "Verified Statement separate "Verified Statement [e.g. for Independent Invent	or, Small Business Concern,

Note: A post office address must be provided for each inventor.

Signature: Full name of 4th joint inventor (if any): Hiro Chib Residence: Citizenship:	aki OGAWA a, Japan n
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